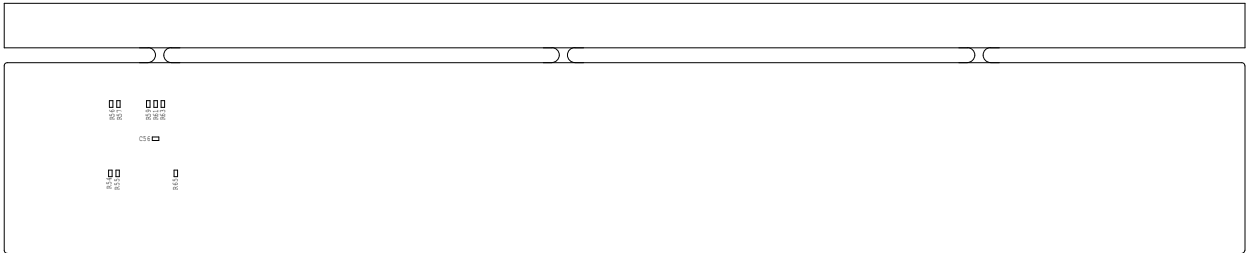


PROC070 E3 ASSEMBLY TOP

- ASSEMBLY NOTES:-
- 1 - All MSL components should be baked as per JEDEC standard.
 - 2 - PCB should be baked at 120 degree for 8 hours.
 - 3 - Board assembly must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
 - 4 - These assemblies are ESD sensitive, ESD precautions shall be observed.
 - 5 - These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 - 6 - Provide serial numbers to the assembled boards for identification.
 - 7 - The assembled board are wrapped in ESD Covers(individual) and packed securely before shipment.



ASSEMBLY NOTES:-

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